## SiHH11N65EF



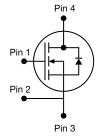
**Vishay Siliconix** 

## **E Series Power MOSFET with Fast Body Diode**

PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.332				
Q <sub>g</sub> max. (nC)	70				
Q <sub>gs</sub> (nC)	8				
Q <sub>gd</sub> (nC)	15				
Configuration	Single				

### PowerPAK<sup>®</sup> 8 x 8





N-Channel MOSFET

### FEATURES

- Completely lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)
- Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and Halogen-free	SiHH11N65EF-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25 \degree C$ , unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage	V <sub>DS</sub>	650	V			
Gate-Source Voltage	V <sub>GS</sub>	± 30	v			
Continuous Drain Current (T <sub>J</sub> = 150 °C)	$V_{GS}$ at 10 V $\frac{T_{C} = 25}{T_{C} = 100}$	°C	11			
	$V_{GS}$ at 10 V $T_{C} = 100$	°C I <sub>D</sub>	7	A		
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	27				
Linear Derating Factor		1	W/°C			
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	127	mJ			
Maximum Power Dissipation	PD	130	W			
Operating Junction and Storage Temperature R	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C			
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C	dV/dt	70	V/ns		
Reverse Diode dV/dt <sup>c</sup>	dv/dl	26	v/ns			

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

- b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 3 A.
- c.  $I_{SD} \leq I_D,\, dI/dt$  = 100 A/µs, starting  $T_J$  = 25 °C.

1



COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RATII	NGS							
PARAMETER	SYMBOL	TYP.	TYP. MAX.			UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	42 55			00.004			
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	0.72 0.96			°C/W			
		·						
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u	nless otherwi	ise noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static						•		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 μA	650	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I <sub>D</sub> = 10 mA	-	0.75	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}$ , $I_D = 2$	250 µA	2.0	-	4.0	V
Cata Source Laskage		N N	$I_{\rm GS} = \pm 20$	V	-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>	\ \	$I_{\rm GS} = \pm 30$	V	-	-	± 1	μA
Zene Osta Visitana Dusia Comunat		V <sub>DS</sub> =	520 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	<u> </u>
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 520 V	, V <sub>GS</sub> = 0 V	′, T <sub>J</sub> = 125 °C	-	-	500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I	<sub>D</sub> = 6 A	-	0.332	0.382	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> :	= 6 A	-	4.6	-	S
Dynamic								
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V_{S}$	_	-	1243	-	_
Output Capacitance	C <sub>oss</sub>	· · ·	/ <sub>DS</sub> = 100 \	V,	-	62	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1 MHz		-	4	-		
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	N 0111 500 111 011		-	44	-	pF	
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>	$v_{\rm DS} = 0.0$	$V_{DS} = 0 V$ to 520 V, $V_{GS} = 0 V$		-	171	-	
Total Gate Charge	Qg				-	35	70	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 6 A	, V <sub>DS</sub> = 520 V	-	8	-	
Gate-Drain Charge	Q <sub>gd</sub>				-	15	-	
Turn-On Delay Time	t <sub>d(on)</sub>				-	19	38	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	= 520 V, I <sub>D</sub>	= 6 A,	-	26	52	1
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>GS</sub> =	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	43	86	ns
Fall Time	t <sub>f</sub>	1		-	25	50	1	
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.4	0.7	1.4	Ω	
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	11	Α	
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	21		
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °	C, I <sub>S</sub> = 6 A,	$V_{GS} = 0 V$	-	0.9	1.2	V
Reverse Recovery Time	t <sub>rr</sub>				-	108	216	ns
Reverse Recovery Charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 6 A, dl/dt = 100 A/μs, V <sub>B</sub> = 25 V		-	0.5	1.0	μC	
Reverse Recovery Current	I <sub>RRM</sub>			n <b></b>	-	9.6	-	Α

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

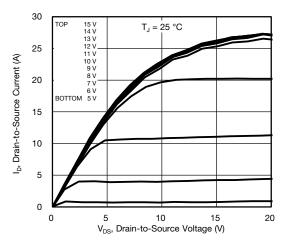


Fig. 1 - Typical Output Characteristics

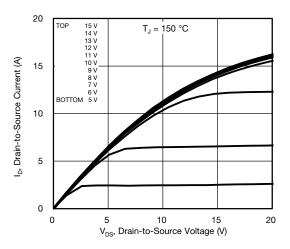


Fig. 2 - Typical Output Characteristics

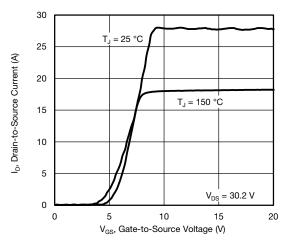


Fig. 3 - Typical Transfer Characteristics

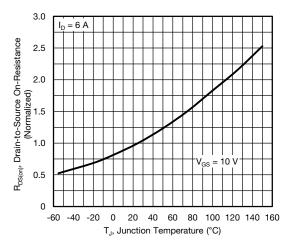


Fig. 4 - Normalized On-Resistance vs. Temperature

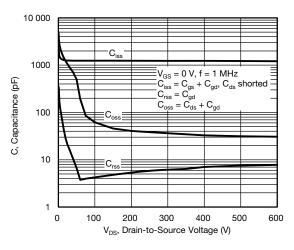


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

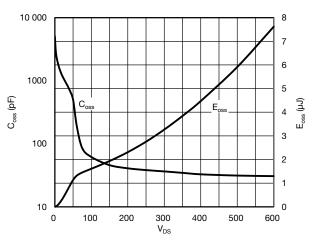


Fig. 6 -  $C_{\text{OSS}}$  and  $E_{\text{OSS}}$  vs.  $V_{\text{DS}}$ 

S16-0524-Rev. A, 21-Mar-16

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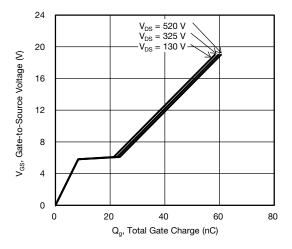


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

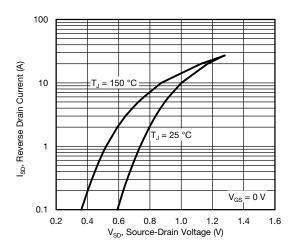


Fig. 8 - Typical Source-Drain Diode Forward Voltage

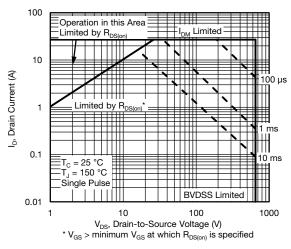


Fig. 9 - Maximum Safe Operating Area

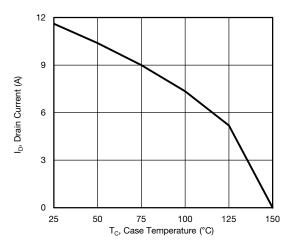


Fig. 10 - Maximum Drain Current vs. Case Temperature

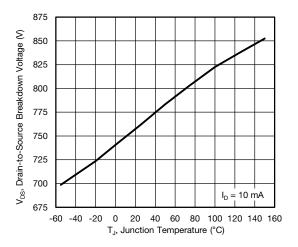


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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4

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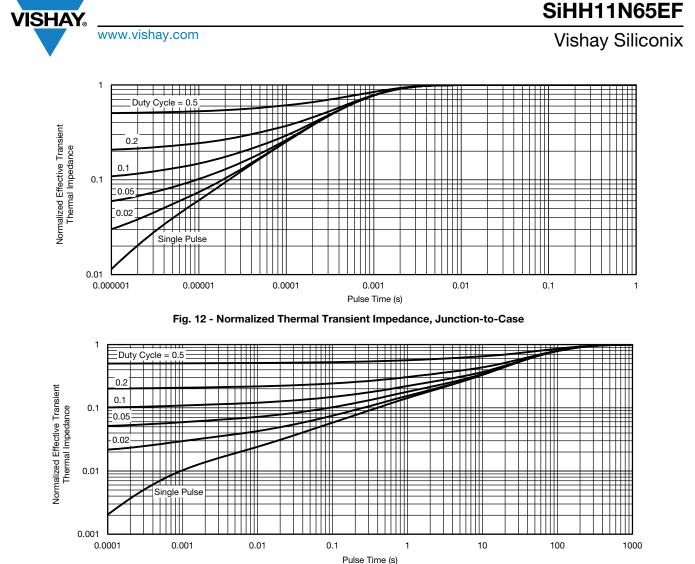


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

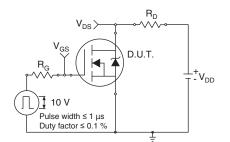


Fig. 14 - Switching Time Test Circuit

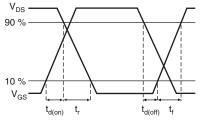


Fig. 15 - Switching Time Waveforms

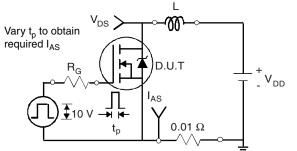


Fig. 16 - Unclamped Inductive Test Circuit

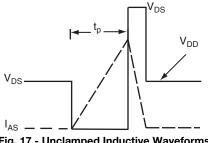
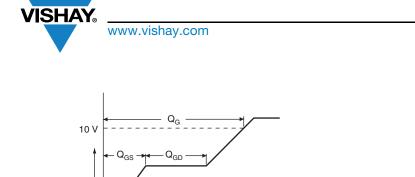


Fig. 17 - Unclamped Inductive Waveforms

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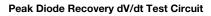
# Current regulator Same type as D.U.T. Same type as D.U.T. D.U.T. V<sub>GS</sub>

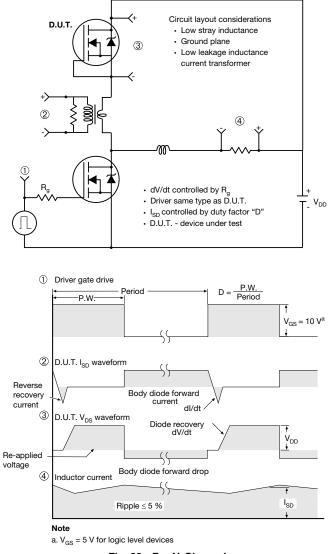
Charge —---



Fig. 18 - Basic Gate Charge Waveform

 $\rm V_G$ 





#### Fig. 20 - For N-Channel

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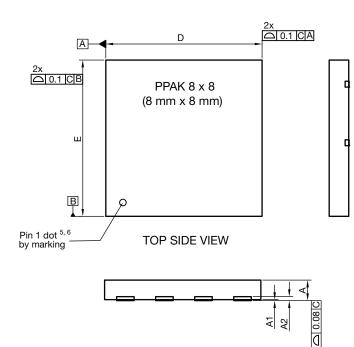
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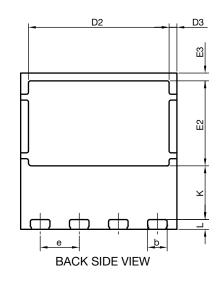
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# PowerPAK<sup>®</sup> 8 x 8 Case Outline





DIM	MILLIMETERS			INCHES			
DIM.	DIM. MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.95	1.00	1.05	0.037	0.039	0.041	
A1	0.00	-	0.05	0.000	-	0.002	
A2		020 ref.		0.008 ref.			
b	0.95	1.00	1.05	0.037	0.039	0.041	
D	7.90	8.00	8.10	0.311	0.315	0.319	
D2	7.10	7.20	7.30	0.280	0.283	0.287	
D3	0.40 BSC			0.016 BSC			
е	2.00 BSC		0.079 BSC				
E	7.90	8.00	8.10	0.311	0.315	0.319	
E2	4.30	4.35	4.40	0.169	0.171	0.173	
E3		0.40 BSC			0.016 BSC		
К	2.75 BSC		0.108 BSC				
L	0.45	0.50	0.55	0.018	0.020	0.022	
N <sup>(3)</sup>	8				8		

#### Notes

<sup>(1)</sup> Use millimeters as the primary measurement

<sup>(2)</sup> Dimensioning and tolerances conform to ASME Y14.5 M - 1994

<sup>(3)</sup> N is the number of terminals

<sup>(4)</sup> The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

<sup>(5)</sup> Exact shape and size of this feature is optional

ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

1



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# Recommended Minimum PADs for PowerPAK<sup>®</sup> 8 mm x 8 mm



**Dimensions in millimeters** 

Document Number: 68441



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